OSRAM GF CSBPM2.24 **Datasheet**

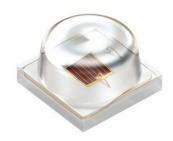




OSLON® Square

GF CSBPM2.24

A new member of the family, OSLON® Square Far Red has a unique innovative radiation pattern to illuminate plants evenly for uniform growth while reducing number of luminaires and lowering overall cost. Additionally, this high-power LED provides excellent reliability, long lifetime and low thermal resistance in a compact footprint.





Applications

- Agriculture & Horticulture
- Entertainment

- Indoor Lighting
- Outdoor & Industrial Lighting

Features

- Package: SMT ceramic package with silicone lens

- Typ. Radiation: 150°

- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

- Radiant Flux: typ. 440 mW

- Radiant Efficiency: typ. 65%

- Photon Flux: typ. 2.66 umol/s

- Photon Flux Efficacy: typ. 3.90 umol/J



Ordering Information

Ordering Code Type Total radiant flux 1)

 $I_{\rm F} = 350 \, \text{mA}$

 $\dot{\varphi}_{E}$

GF CSBPM2.24-TNUJ-1-1 380 ... 485 mW Q65113A5716



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T _{op}	min.	-40 °C
		max.	120 °C
Storage Temperature	T_{stg}	min.	-40 °C
	0.9	max.	120 °C
Junction Temperature	T _j	max.	125 °C
Forward current	I _F	min.	100 mA
	·	max.	1000 mA
Surge Current	I _{FS}	max.	2000 mA
t ≤ 10 μs; D = 0.005 ; T _J = 25 °C	10		
Reverse voltage ²⁾	V_R		Not designed for
	TX		reverse operation
ESD withstand voltage	V _{ESD}		8 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	LOD		



Characteristics

 $I_F = 350 \text{ mA}; T_J = 25 \text{ }^{\circ}\text{C}$

Parameter	Symbol		Values
Peak Wavelength	$\lambda_{\sf peak}$	typ.	730 nm
Centroid Wavelength 3)	$\lambda_{ ext{centroid}}$	min.	710 nm
$I_{\rm F} = 350 \text{ mA}$	3011113111	typ.	727 nm
		max.	740 nm
Spectral Bandwidth at 50% I _{rel,max}	Δλ	typ.	30 nm
Viewing angle at 50% I _v	2φ	typ.	135 °
Forward Voltage 4)	V _F	min.	1.80 V
$I_{\rm F} = 350 \text{ mA}$	·	typ.	1.95 V
		max.	2.10 V
Reverse current 2)	I _R		Not designed for reverse operation
Electrical thermal resistance junction/solderpoint with efficiency η_e = 63 %	$R_{ ext{thJS elec.}}$	typ.	2.7 K / W



Brigl	Brightness Groups							
Group	Total radiant flux ¹⁾ I _F = 350 mA	Total radiant flux $^{1)}$ I _F = 350 mA	PPF *	PPF *	PPF/W*	PF **	PF **	PF/W **
	min.	max.	min.	max.	typ.	min.	max.	typ.
	Φ_{E}	Φ_{E}	Φ_{p}	Φ_{p}		$\boldsymbol{\Phi}_{p,b}$	$\boldsymbol{\Phi}_{p,b}$	
TN	380 mW	415 mW	0.180 μmol/s	0.196 μmol/s	0.28 μmol/J	2.30 µmol/s	2.51 µmol/s	3.52 µmol/J
ТО	415 mW	450 mW	0.196 μmol/s	0.213 μmol/s	0.30 μmol/J	2.51 μmol/s	2.72 µmol/s	3.83 µmol/J
UJ	450 mW	485 mW	0.213 µmol/s	0.229 µmol/s	0.32 µmol/J	2.72 µmol/s	2.93 µmol/s	4.14 µmol/J

Note: [*] Photosynthetic Photon Flux includes wavelengths between 400 and 700 nm Note: [**] Photon Flux includes wavelengths between 280 and 800 nm Note: PPF and PF values are for reference only

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ I _F = 350 mA min. V _F	Forward Voltage ⁴⁾ I _F = 350 mA max. V _F	
E1	1.80 V	1.90 V	
E2	1.90 V	2.00 V	
F1	2.00 V	2.10 V	

Centroid Wavelength

Group	Centroid Wavelength 3)	Centroid Wavelength 3)	
	$I_{\rm F} = 350 \text{ mA}$	I _F = 350 mA	
	min.	max.	
	$\lambda_{\sf centroid}$	$\lambda_{centroid}$	
1	710 nm	740 nm	



Group Name on Label

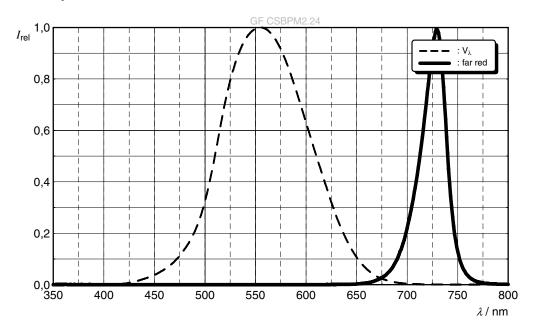
Example: TN-1-E1

Brightness	Wavelength	Forward Voltage
TN	1	E1



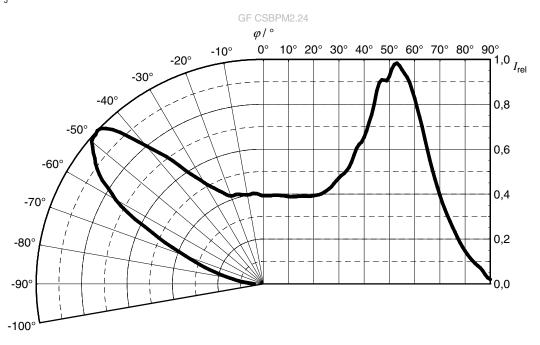
Relative Spectral Emission 5)

 I_{rel} = f (λ); I_F = 350 mA; T_J = 25 °C



Radiation Characteristics 5)

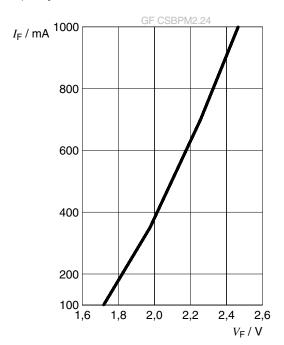
 $I_{rel} = f (\phi); T_J = 25 °C$





Forward current 5)

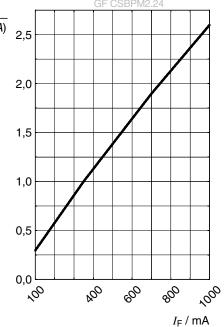
$$I_F = f(V_F); T_J = 25 \, ^{\circ}C$$



Relative Radiant Power 5), 6)

$$\Phi_{\rm E}/\Phi_{\rm E}(350~{\rm mA})$$
 = f(I_F); T_J = 25 °C

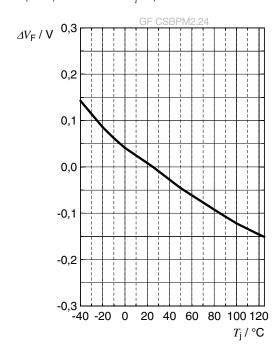






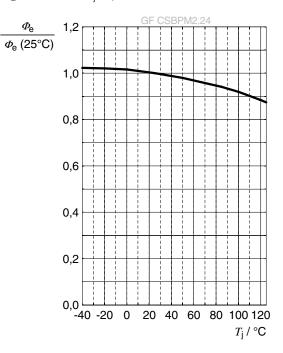
Forward Voltage 5)

$$\Delta V_{_F} = V_{_F} - V_{_F} (25~^{\circ}C) = f(T_{_j}); I_{_F} = 350~mA$$



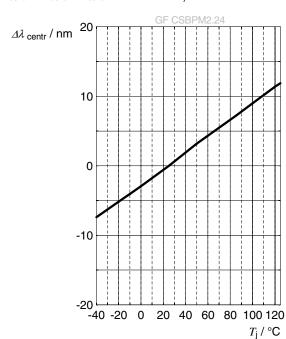
Relative Radiant Power 5)

$$\Phi_{\rm E}/\Phi_{\rm E}(25~{\rm ^{\circ}C}) = f(T_{\rm i}); I_{\rm E} = 350~{\rm mA}$$



Centroid Wavelength 5)

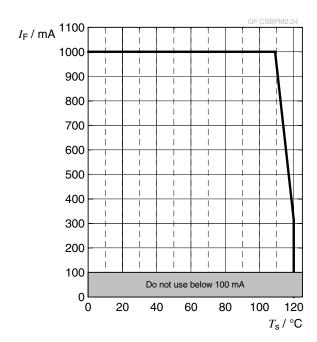
$$\Delta \lambda_{centr} = \lambda_{centr} - \lambda_{centr} (25~^{\circ}C) = f(T_{j});~I_{_{F}} = 350~mA$$





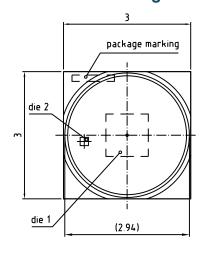
Max. Permissible Forward Current 7)

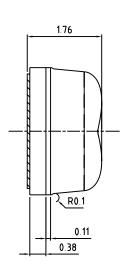
 $I_F = f(T)$

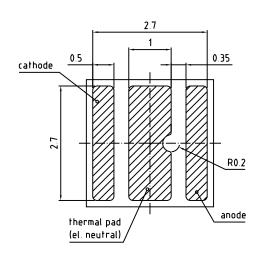




Dimensional Drawing 8)







General tolerance ±0.1 Lead finish Au

C69062-A0010-A3-02

Further Information:

Approximate Weight: 27.0 mg

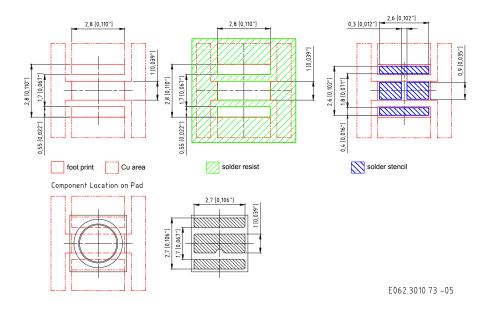
Package marking: Anode

ESD advice: The device is protected by ESD device which is connected in parallel to the

Chip.



Recommended Solder Pad 8)

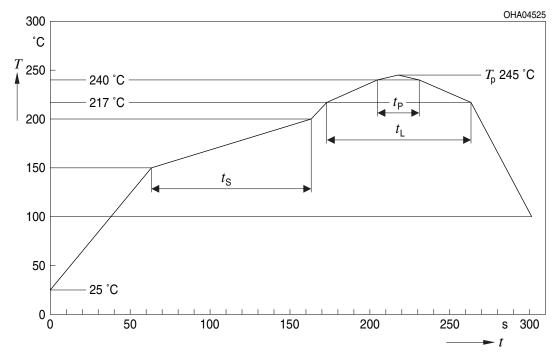


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Further information can be found in our Application Note: "Handling and Processing Details for Ceramic LEDs".



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



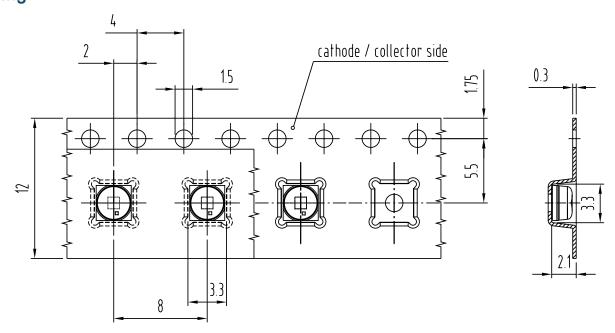
Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly		Unit	
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*)	'		2	3	K/s
25 °C to 150 °C					
Time t _s	t _s	60	100	120	S
T_{Smin} to T_{Smax}					
Ramp-up rate to peak*)			2	3	K/s
T_{Smax} to T_{P}					
Liquidus temperature	T_{L}		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle \perp}$		80	100	S
Peak temperature	T _P		245	260	°C
Time within 5 °C of the specified peak temperature T _p - 5 K	t _P	10	20	30	S
Ramp-down rate* T _P to 100 °C			3	6	K/s
Time 25 °C to T _P				480	S

All temperatures refer to the center of the package, measured on the top of the component

^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



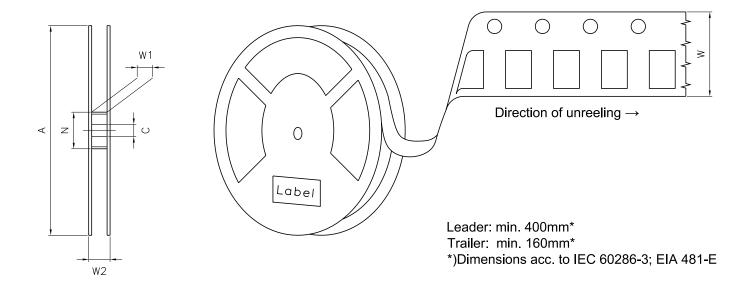
Taping 8)



C69062-A0010-B8 02



Tape and Reel 9)

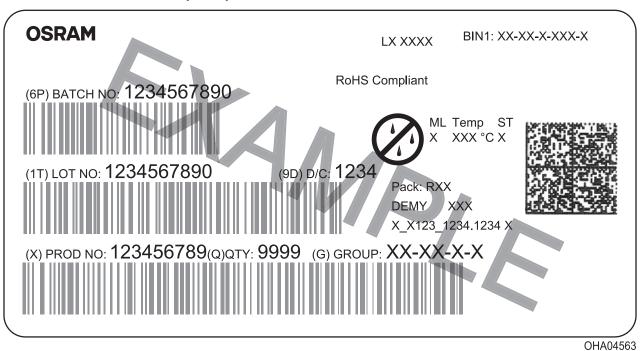


Reel Dimensions

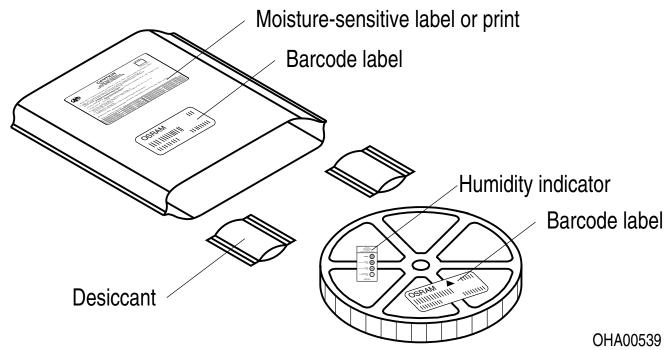
Α	W	N_{\min}	W_1	$W_{2\text{max}}$	Pieces per PU
330 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	3000



Barcode-Product-Label (BPL)



Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class low risk (exposure time 100 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

This device is designed for specific/recommended applications only. Please consult OSRAM Opto Semiconductors Sales Staff in advance for detailed information on other non-recommended applications (e.g. automotive).

Change management for this component is aligned with the requirements of the lighting market.

For further application related information please visit https://ams-osram.com/support/application-notes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



Glossary

- Brightness: Brightness values are measured during a current pulse of typically 10 ms, with a tolerance of +/- 7%.
- 2) Reverse Operation: Not designed for reverse operation. Continuous reverse operation can cause migration and damage of the device.
- 3) Wavelength: The wavelength is measured at a current pulse of typically 10 ms, with a tolerance of ± 0.5 nm.
- Forward Voltage: The Forward voltage is measured during a current pulse duration of typically 1 ms with a tolerance of $\pm 0.05V$.
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 6) Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 7) Thermal Resistance: Rth max is based on statistic values (6 σ) used for Derating.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- 9) Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision History

	•	
Version	Date	Change
1.0	2021-09-23	Initial Version
1.1	2023-03-20	Brightness Groups Forward Voltage Groups Characteristics
1.2	2023-08-02	Features



EU RoHS and China RoHS compliant product 此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准, 不含有毒有害物质或元素。

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